

# Silicon Metasurfaces for Integrated Dual Polarized 1.9 THz Heterodyne Array Instruments

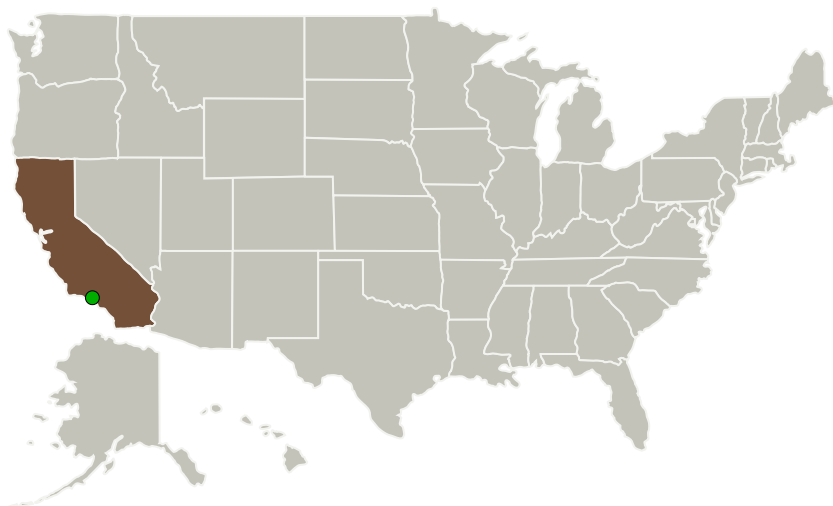
Completed Technology Project (2017 - 2020)



## Project Introduction

We propose the use of dielectric metasurfaces as the enabling technology to develop a dual polarized heterodyne receiver array with full mapping of the field of view at 1.9 THz. Current heterodyne and non-heterodyne arrays at 1.9 THz are restricted to have sparse mapping in the field of view due to the minimum physical inter-element spacing required between the pixels. Moreover, an integrated dual polarized heterodyne receiver is very difficult to achieve with current technologies at 1.9 THz. We propose the use of metasurfaces that will split the 1.9 THz radiation into two linear polarizations and focus them both on the same receiver plane. Additionally, by overlapping common regions of the metasurface we will have a full mapping of the field of view, i.e. the beams will be highly overlapped in the field of sky observation which is not the case with current generation of array instruments. The metasurface consists of a dielectric planar structure with subwavelength 3D features that controls the amplitude and phase of the electric field that goes through them. These structures are usually used in reflection in the microwave frequency range and has not been used at terahertz frequencies before. We propose the development of these metasurfaces in transmission and integrate them into a multi-pixel heterodyne receiver at 1.9 THz. The silicon micro-machining process developed at JPL allows the fabrication of high aspect ratio multi-depth features on silicon wafers and will allow the integration of both, receiver and metasurfaces, in the same wafer stack. It will lead to a more compact, low-mass, and low loss dual polarized multi-pixel receiver with efficient illumination at 1.9 THz. Even though this work will target the 1.8-2.1 THz band for the CII and OI lines, these designs can be easily scaled to at least 5 THz.

## Primary U.S. Work Locations and Key Partners



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## Organizational Responsibility

### Responsible Mission Directorate:

Science Mission Directorate (SMD)

### Lead Organization:

California Institute of Technology (CalTech)

### Responsible Program:

Astrophysics Research and Analysis

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Organizations Performing Work	Role	Type	Location
California Institute of Technology(CalTech)	Lead Organization	Academia	Pasadena, California
● Jet Propulsion Laboratory(JPL)	Supporting Organization	NASA Center	Pasadena, California

## Primary U.S. Work Locations

California

## Project Management

**Program Director:**

Michael A Garcia

**Program Manager:**

Dominic J Benford

**Principal Investigator:**

Maria Alonso Del Pino

**Co-Investigators:**

Andrei Faraon  
Paul F Goldsmith  
Karen R Piggee  
Theodore J Reck  
Cecile Jung-kubiak  
Goutam Chattopadhyay

## Technology Areas

**Primary:**

- TX08 Sensors and Instruments
  - └ TX08.1 Remote Sensing Instruments/Sensors
    - └ TX08.1.4 Microwave, Millimeter-, and Submillimeter-Waves

## Target Destination

Outside the Solar System